

REMARKS

Claims 1-16 are pending in the present application.

In response to the Examiner's question, Group II claims Figures 8-9 and Group III claims Figures 10-14.

In response to the examiner's objection to the title of the invention not being descriptive, Applicant has amended the title to read "An Interposing Structure" to be more descriptive of the claimed invention.

In response to the Examiner's objection to page 12, paragraph [0057], lines 11-13, of the specification under 35 USC 112 first paragraph, Applicant has amended the specification to read: "Similarly, the balls of the packaged IC 102 are mounted (e.g. soldered) to the lands on the top surface of [[PCB 101]] interposer 103. The applicant requests the objection be withdrawn.

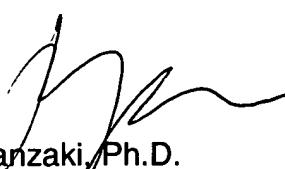
Applicant responds to the further restriction requirement by electing Group I, Claims 1-8 and 12-16, with traverse. Applicant cancels Claims 9-11 but reserves the right to pursue these claims in a divisional or continuation application.

CONCLUSION

All claims should be now be in condition for allowance and a Notice of Allowance is respectfully requested.

If there are any questions, the applicants' attorney can be reached at Tel: 408-879-6149 (Pacific Standard Time).

Respectfully submitted,



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I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, Virginia 22313-1450, on June 27, 2005.

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